

N-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

BV _{DSS} /	V_{DSS} / $R_{DS(ON)}$ $I_{D(ON)}$		Order Number / Package		
BV _{DGS}	(max)	(min)	TO-92	20-Pin C-Dip	
220V	1.25Ω	5.0A	_	VN2222NC	
240V	1.25Ω	5.0A	VN2224N3	_	

High Reliability Devices

See pages 5-4 and 5-5 for MILITARY STANDARD Process Flows and Ordering Information.

Features

- Free from secondary breakdown
- Low power drive requirement
- □ Ease of paralleling
- ☐ Low C_{ISS} and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain

Applications

- ☐ Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

Absolute Maximum Ratings

Drain-to-Source Voltage	BV _{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

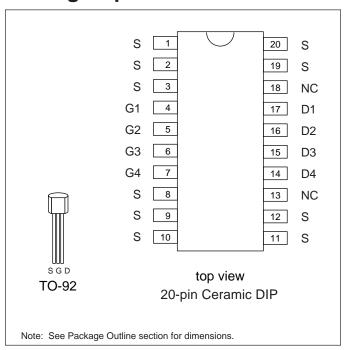
^{*} Distance of 1.6 mm from case for 10 seconds.

Advanced DMOS Technology

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



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Thermal Characteristics

Package	I _D (continuous)*	I _D (pulsed)	Power Dissipation @ T _C = 25°C	$^{ heta_{ m jc}}$ $^{\circ}$ C/W	$ heta_{ja}$ °C/W	I _{DR} *	I _{DRM}
TO-92	540mA	5.0A	1.0W	125	170	540mA	5.0A

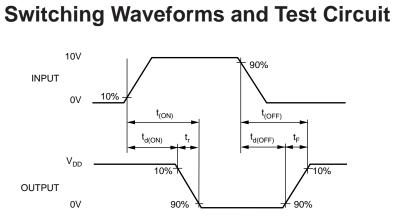
^{*} I_D (continuous) is limited by max rated T_D

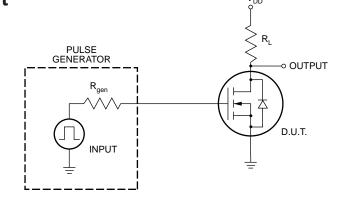
Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter		Min	Тур	Max	Unit	Conditions	
BV _{DSS}	Drain-to-Source Breakdown Voltage	VN2224 VN2222	240 220			V	$V_{GS} = 0V$, $I_D = 5mA$	
$V_{GS(th)}$	Gate Threshold Voltage	1	1.0		3.0	V	$V_{GS} = V_{DS}$, $I_D = 5mA$	
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with Temperature			-4	-5	mV/°C	$V_{GS} = V_{DS}, I_D = 5mA$	
I _{GSS}	Gate Body Leakage			1	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
I _{DSS}	I _{DSS} Zero Gate Voltage Drain Current				50	μΑ	$V_{GS} = 0V$, $V_{DS} = Max$ Rating	
					5	mA	$V_{GS} = 0V$, $V_{DS} = 0.8$ Max Rating $T_A = 125$ °C	
I _{D(ON)}	I _{D(ON)} ON-State Drain Current		2			А	$V_{GS} = 5V, V_{DS} = 25V$	
			5	10			V _{GS} = 10V, V _{DS} = 25V	
R _{DS(ON)}	Static Drain-to-Source			1.0	1.5	Ω	$V_{GS} = 5V$, $I_D = 2A$	
	ON-State Resistance			0.9	1.25		$V_{GS} = 10V$, $I_D = 2A$	
$\Delta R_{\text{DS(ON)}}$	Change in R _{DS(ON)} with Temperature			1.0	1.4	%/°C	$V_{GS} = 10V$, $I_D = 2A$	
G_{FS}	Forward Transconductance		1.0	2.2		Ω	$V_{DS} = 25V$, $I_D = 2A$	
C _{ISS}	Input Capacitance Common Source Output Capacitance			300	350	pF	$V_{GS} = 0V, V_{DS} = 25V$ f = 1 MHz	
Coss				85	150			
C_{RSS}	Reverse Transfer Capacitance			20	35	1 – 1 1011 12		
t _{d(ON)}	Turn-ON Delay Time			6	15			
t _r	Rise Time Turn-OFF Delay Time			16	25	- ns	$V_{DD} = 25V$ $I_{D} = 2A$ $R_{GEN} = 10\Omega$	
t _{d(OFF)}				65	90			
t _f	Fall Time			30	60			
V_{SD}	Diode Forward Voltage Drop			0.8	1.0	V	$V_{GS} = 0V, I_{SD} = 100 \text{mA}$	
t _{rr}	Reverse Recovery Time			500		ns	$V_{GS} = 0V$, $I_{SD} = 1A$	

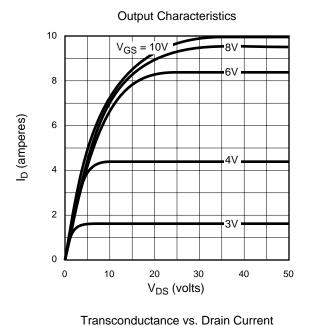
Notes:

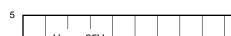
- 1. All D.C. parameters 100% tested at 25 °C unless otherwise stated. (Pulse test: $300\mu s$ pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

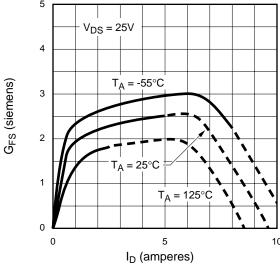




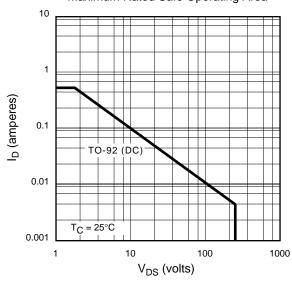
Typical Performance Curves



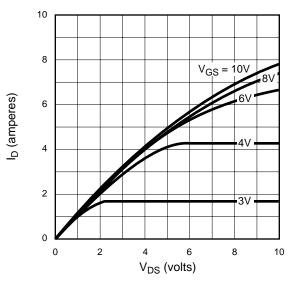




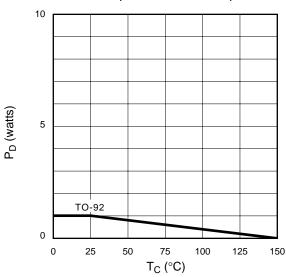
Maximum Rated Safe Operating Area



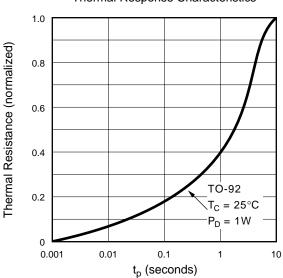
Saturation Characteristics



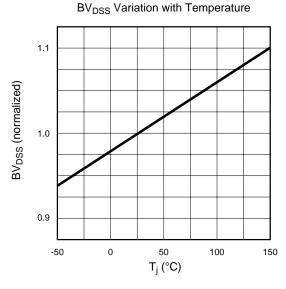
Power Dissipation vs. Case Temperature

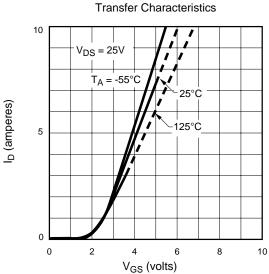


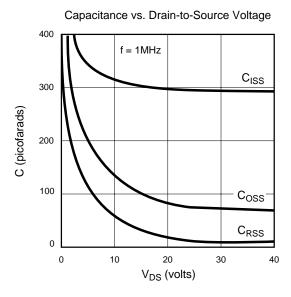
Thermal Response Characteristics

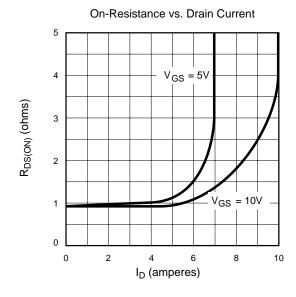


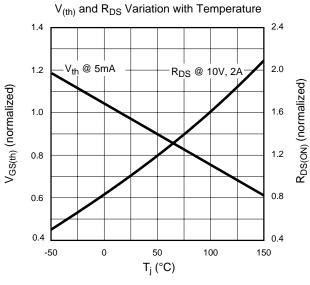
Typical Performance Curves

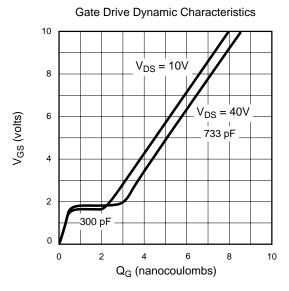












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Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip:

<u>VN2224N3-P002-G VN2224N3-G VN2224N3-P014-G VN2224N3-P002 VN2224N3-P013 VN2224N3-P003</u>

<u>VN2224N3-P014 VN2222NC VN2224N3 VN2224N3-P013-G VN2224N3-P003-G VN2224N3-G P002 VN2224N3-G P005 VN2224N3-G P014 VN2224N3-G P003 VN2224N3-G P013</u>